

## **Features**

- Meets the TIA/EIA- 422-B requirements
- High speed, up to 50Mbps data rate, and tPLH = tPHL = 17 ns typical
- Low pulse distortion, tsk(p) = 0.7 ns typical
- -7V ~ +12V Common-Mode Range With ±200mV sensitivity
- Input Hysteresis: 40 mV typical
- Wide power supply voltage 3.0V to 5.5V
- Bus-Pin Protection:
  - ±18 kV HBM protection
  - ±10 kV IEC-Contact ESD
  - ±15 kV IEC-Air Charge ESD
- Pb-Free
- Package: SOP16, TSSOP16

## **Applications**

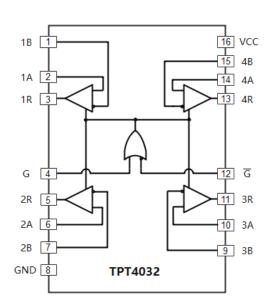
- Field Transmitters: Temperature Sensors and Pressure Sensors
- Motor Controller and Position Encoder Systems
- Factory Automation
- Industrial Control Networks
- •

### Description

3PEAK's TPT4032 is an enhanced RS422 device which meets standard TIA/EIA-422-B with strong ESD protection capability. The BUS-pin can pass ±18kV HBM-ESD, and ±15 kV IEC-Air Charge ESD protection. It works in wide power supply range: from 3.0V to 5.5V VCC, which design quad receiver for balanced communication. It also features the wide input common-mode voltage and higher data rate, the TPT4032 can accept -7V ~ +12V common-mode differential input with 100  $\Omega$  Load and 50Mbps data rate in 5.0V power supply, required by high speed field-bus applications.

The TPT4032's enable functions can control all four receivers and provide an active-high (G) or active-low (/G) enable input, and they provide the high-impedance state in the power-off condition, which only consume <1uA very low current.

The TPT4032 is available in an SOP16 and TSSOP16 package, and is characterized from –40°C to 125°C.



### **Typical Application Circuit**



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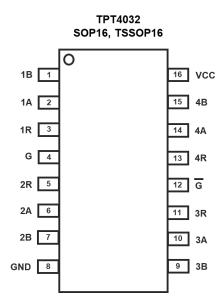


# **Revision History**

Date	Revision	Notes
2020/11/18	Rev. Pre.0	Definition Version Pre.0
2021/5/26	Rev. 0	Released version
2021/7/21	Rev. A	Updated the Unit of $V_{IT+}$ , $V_{IT-}$
2022/4/26	Rev. A.1	Updated the order information
2023/7/21	Rev. A.2	Updated the type of $V_{IH}V_{IL}$ test condition in page 7



# **Pin Configuration and Functions**



### **Pin Functions**

Pi	n	I/O	Description
1B	1	I	RS422/RS485 differential input (inverting)
1A	2	I	RS422/RS485 differential input (noninverting)
1R	3	0	Logic level output
G	4	I	Active-high select
2R	5	0	Logic level output
2A	6	I	RS422/RS485 differential input (noninverting)
2B	7	I	RS422/RS485 differential input (inverting)
GND	8		Ground
3B	9	I	RS422/RS485 differential input (inverting)
3A	10	I	RS422/RS485 differential input (noninverting)
3R	11	0	Logic level output
/G	12	I	Active-low select
4R	13	0	Logic level output
4A	14	I	RS422/RS485 differential input (noninverting)
4B	15	I	RS422/RS485 differential input (inverting)
VCC	16		Power pin



## **Absolute Maximum Ratings**

Parameter	Description	Min	Мах	Unit
VCC	VCC Supply voltage -		7	V
VI	Input voltage (G, /G)	-0.3	VCC + 0.3	V
V <sub>CM</sub>	Common-mode input voltage	-10	+15	V
Vo	Output voltage	-0.5	VCC+0.5	V
lıк Іок	Input or output clamp current		±20	mA
lo	Output current		±20	mA
los	Short-circuit output current		200	mA
TJ	Operating virtual junction temperature		150	°C
Tstg	Storage temperature	-65	150	°C

\* **Note:** Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

(1) This data was taken with the JEDEC low effective thermal conductivity test board.

(2) This data was taken with the JEDEC standard multilayer test boards.

### **Recommended Operating Conditions**

Parameter	Description	Min	Мах	Unit
VCC	Supply voltage	3.0	5.5	V
Viн	High-level input voltage (receiver enable inputs)	2	VCC	V
VIL	Low-level input voltage (receiver enable inputs)	0	0.8	V
Vсм	Common-mode input voltage	-7	+12	V
RL	Differential load resistance	100		Ω
T <sub>A</sub>	Operating ambient temperature	-40	125	°C

(1) The algebraic convention, in which the least positive (most negative) limit is designated as minimum is used in this data sheet.



### **ESD**, Electrostatic Discharge Protection

Symbol	Parameter	Condition	Minimum Level	Unit
150	IEC Contact Discharge	IEC-61000-4-2, Bus Pin	±10	kV
IEC	IEC Air-Gap Discharge	IEC-61000-4-2, Bus Pin	±15	kV
		ANSI/ESDA/JEDEC JS-001, Bus Pin	±10	kV
HBM	Human Body Model ESD	ANSI/ESDA/JEDEC JS-001, All Pin		kV
CDM	Charged Device Model ESD	ANSI/ESDA/JEDEC JS-002, All Pin	±1.5	kV
LU	Latch up	LU, per JESD78, All Pin <sup>(3)</sup>	±500	mA

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

(3) Test at the temperature of 25°CC .temperature

## **Thermal Information**

Package Type	θ <sub>JA</sub>	θ <sub>JC</sub>	Unit
16-Pin TSSOP	118	52	°C/W
16-Pin SOP	93	35	°C/W

Note:

(1) Parameter is provided from 1S0P PCB per JEDEC standard

(2)  $\theta_{JA}, \theta_{JC}$  data is only for reference by design simulation



## **Electrical Characteristics**

Typical value is in VCC = 5.0V, TA = +25°C, RL = 100 $\Omega$  to GND, unless otherwise noted.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Input Electri	ical Specifications		- 1			
V <sub>IK</sub>	Enable-input clamp voltage	I <sub>0</sub> = 18 mA		-0.8	-1.5	V
V <sub>IH</sub>	Logic Input High Voltage	G, /G	2.0			V
V <sub>IL</sub>	Logic Input Low Voltage	G, /G			0.8	V
Vон	High-level output voltage	I <sub>OH</sub> = -6mA, V <sub>ID</sub> = +200mV	3.8	4.89		V
Vol	Low-level output voltage	I <sub>OL</sub> = 6mA, V <sub>ID</sub> = -200mV		0.11	0.4	V
V <sub>IT+</sub>	Differential input high-threshold voltage, positive	VI = -7 V to 12 V			0.2	V
V <sub>IT-</sub>	Differential input low-threshold voltage, negative	VI = -7 V to 12 V	-0.2			V
$V_{\text{HYS}}$	Hysteresis voltage (1)	$V_{IT+} - V_{IT} -$		40		mV
Rin	Input resistance	VI = -7V to12V, one input to ground	96	176		kΩ
		VI=12V,Other input at -7V to 12V		48	150	uA
I <sub>I (A/B)</sub>	Line input current	VI=-7V,Other input at -7V to 12V		61	150	uA
I <sub>H(G,/G)</sub>	High level enable current (2)	VI=VCC		3.2	10	uA
I <sub>L(G,/G)</sub>	Low level enable current (2)	VI=GND	-10	-2.6		uA
I <sub>oz</sub>	OFF state(High-impedance-state) output current	Vo=0V or VCC	-1	0	1	uA
los	Short-circuit output current	VCC=MAX,Vo=0V,VID>=0.2V	-180	-103		mA
lcc	Quiescent supply current	G,/G=VCC or GND,100 ohm Line inputs resistor		6.5	10	mA
Ci	Input capacitance <sup>(1)</sup>			18		pF

(1). Test data based on bench test and design simulation

(2). Internal weak pull in/up resistor

### **AC Electrical Specifications**

#### Typical value is in VCC = 5.0V, TA = +25°C, RL = $100\Omega$ to GND

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
tPLH	Propagation delay time, low-to-high- level output	SW is open and Figure 1. CL=15pF		16	30	ns
tPHL	Propagation delay time, high-to-low- level output	SW is open, see Figure 1 , CL=15pF		19	30	ns
tsk(p)	Pulse skew time ( $ t_{PLH} - t_{PHL} $ )	SW is open, see Figure 1		3	7	ns
tr	Differential output rise times			3.7	11	ns
tr	Differential output fall times	SW is open, see Figure 1, CL=15pF		2.2	11	ns
tPZH	Output enable time to high level			10	40	ns
tPZL	Output enable time to low level	SW is closed, see Figure 3, CL=50pF		13	40	ns



tPHZ	Output disable time from high level	SW is closed, see Figure 3, CL=50pF	27	40	ns
tPLZ	Output disable time from low level	SW is closed, see Figure 3, CL-30pr	24	40	ns
Cpd	Power dissipation capacitance (1)	SW is open, see Figure 2	34		pF

(1). Test data based on bench test and design simulation

### **Electrical Characteristics (Continue)**

## Typical value is in VCC = 3.3V, TA = +25°C, RL = 100 $\Omega$ to GND, unless otherwise noted.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Input Electri	ical Specifications					
VIK	Enable-input clamp voltage	I <sub>o</sub> = 18 mA		-0.8	-1.5	V
VIH	Logic Input High Voltage	G, /G	2.0			V
VIL	Logic Input Low Voltage	G, /G			0.8	V
Vон	High-level output voltage	I <sub>OH</sub> = -6mA, V <sub>ID</sub> = +200mV	2.7	3.47		V
Vol	Low-level output voltage	I <sub>OL</sub> = 6mA, V <sub>ID</sub> = -200mV		0.16	0.4	V
V <sub>IT+</sub>	Differential input high-threshold voltage	VI = -7 V to 12 V			0.2	mV
V <sub>IT-</sub>	Differential input low-threshold voltage	VI = -7 V to 12 V	-0.2			mV
V <sub>HYS</sub>	Hysteresis voltage <sup>(1)</sup>	$V_{IT+} - V_{IT-}$		40		mV
Rin	Input resistance	VI = -7V to12V, one input to ground	96	176		kΩ
	I for a formula community	VI=12V,Other input at -7V to 12V		50	150	uA
I <sub>I (A/B)</sub>	Line input current	VI=-7V,Other input at -7V to 12V		54	150	uA
I <sub>H(G,/G)</sub>	High level enable current	VI=VCC		2.1	5.5	uA
$I_{L(G,/G)}$	Low level enable current	VI=GND		2.0	5.5	uA
l <sub>oz</sub>	OFF state(High-impedance-state) output current	Vo=0V or VCC	-1	0	1	uA
los	Short-circuit output current	VCC=MAX,Vo=0V,VID>=0.2V	-85	-58		mA
Icc	Quiescent supply current	G,/G=VCC or GND,100 ohm Line inputs resistor		6.2	8	mA
Ci	Input capacitance <sup>(1)</sup>			14		pF

(1). Test data based on bench test and design simulation



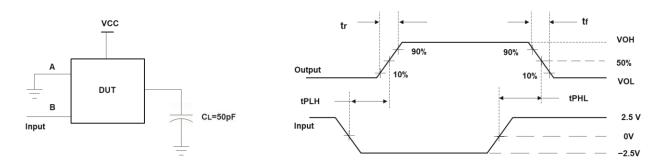
### **AC Electrical Specifications**

Typical value is in VCC = 3.3V, TA = +25°C, RL = 100 $\Omega$  to GND, unless otherwise noted.

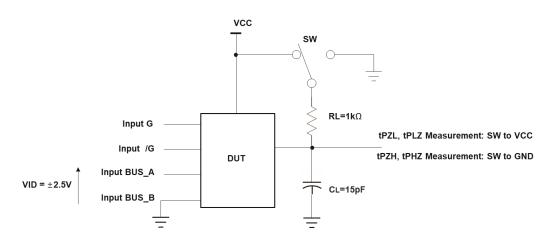
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
tPLH	Propagation delay time, low-to-high- level output	SW is open and Figure 1 CI =15pE		22	30	ns
tPHL	Propagation delay time, high-to-low- level output	SW is open, see Figure 1 , CL=15pF		22	30	ns
tsk(p)	Pulse skew time $( t_{PLH} - t_{PHL} )$	SW is open, see Figure 1		1.3	6	ns
tr	Differential output rise times			3.3	11	ns
tr	Differential output fall times	SW is open, see Figure 1, CL=15pF		3.4	11	ns
tPZH	Output enable time to high level	SW/ is closed and Figure 2. CL=E0pE		14	40	ns
tPZL	Output enable time to low level	SW is closed, see Figure 3, CL=50pF		13	40	ns
tPHZ	Output disable time from high level			27	40	ns
tPLZ	Output disable time from low level	SW is closed, see Figure 3, CL=50pF		24	40	ns
Cpd	Power dissipation capacitance (1)	SW is open, see Figure 2		27		pF

(1). Test data based on bench test and design simulation

## **Test Circuits and Waveforms**



#### Figure 1. Receiver Propagation Delay and Output Transition Times Measurement







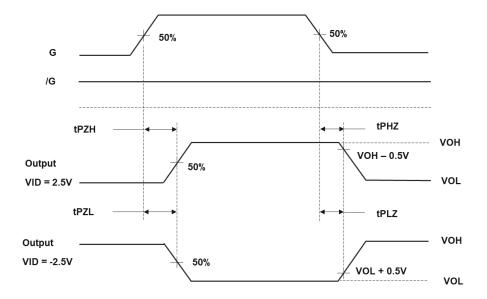


Figure 3A. Receiver Propagation Delay and Differential Transition Times

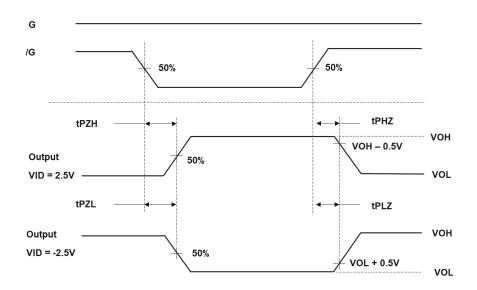


Figure 3B. Receiver Propagation Delay and Differential Transition Times

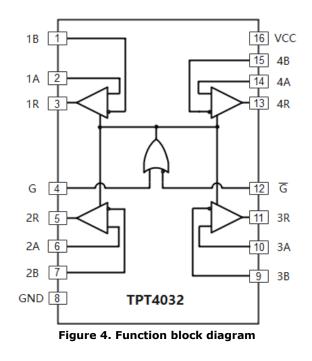


## **Theory of Operation**

### **Overview**

3PEAK's TPT4032 is an enhanced RS422 device which meets standard TIA/EIA-422-B with strong ESD protection capability. The BUS-pin can pass ±18kV HBM-ESD, and ±15 kV IEC-Air ESD protection. It works in wide power supply range: from 3.0V to 5.5V VCC, which design quad receiver for balanced communication. It also features the wide input common-mode voltage and higher data rate, the TPT4032 can accept -7V ~ +12V common-mode differential input with 100  $\Omega$  Load and 50Mbps data rate in 5.0V power supply, required by high speed field-bus applications. The TPT4032 only consume <1uA very low current in the power-off condition.

## **Function block diagram**



### **Feature Description**

#### -7V ~ +12V Common-Mode Range With ±200-mV Sensitivity

For a common-mode voltage range from -7V to +12V, the input voltage is acceptable in low ranges greater than 200 mV as a standard.

#### Input Fail-Safe function

RS-485 specifies that the receiver output state should be logic high for differential input voltages of VAB  $\geq$  +200 mV and logic low for VAB  $\leq$  -200 mV. For input voltages in between these limits, the receiver output state is not defined and can randomly be high or low. In some abnormal case, if the input signal is removed, the receiver output is defined as certain state (typically high) through internal biasing circuits.

A loss of input signal can be caused by an pen circuit caused by a wire break or the unintentional disconnection of a transceiver from the bus. The TPT4032 has an internal circuit that ensures functionality during an idle bus.

#### Active-High in G and Active-Low in /G

The G and /G logic inputs can configure the device to select receiver output status, and set a logic high on the G pin or a logic low on the /G pin to enable the device in normal operation mode, and it is easy to configure the logic from a controller or microprocessor.

#### Power supply

Both the logic and transmitters operate from a single power supply in wide range:  $3.0 \sim 5.5$ V, making designs much more easily. The line quad drivers can operate off the same rail as the host controller or a similar low voltage supply, thus simplifying power structure. The 5.0V power supply is recommended to get better performance, especially in high data rate up-to 50Mbps.

#### **Device Functional Modes**

Differential Input	Ena	Outputs	
A-B	G	/G	R
	Н	Х	Н
VID ≥ VIT+	Х	L	Н
VIT < VID < VIT+	Н	х	?
	Х	L	?
	Н	Х	L
Vid ≤ Vit-	Х	L	L
Х	L	Н	Z

Note:

H = High level, L = Low level, X = Irrelevant, Z = High impedance (off)

### Application and Implementation

#### Application Information

A typical system usually contain the drivers, receivers, and transceivers complied with RS-422, to reduce reflections in the transmission line, requires the proper cable termination for highly reliable applications. Only one driver on the bus is allowed per RS422 standard, as termination is used in circuit and it is usually placed at the end of the cable near the last receiver. In order to get the good performance and low cost of the application, and decide the type of termination. The different types of termination are unterminated lines, parallel termination, AC termination, and multipoint termination. For laboratory experiments, around 50 meter of  $100-\Omega$ , twisted-pair cable, a single driver and receiver, 3PEAK TPT4031 and TPT4032 were tested at room temperature with in 5.0V supply voltage.



#### **Typical Application**

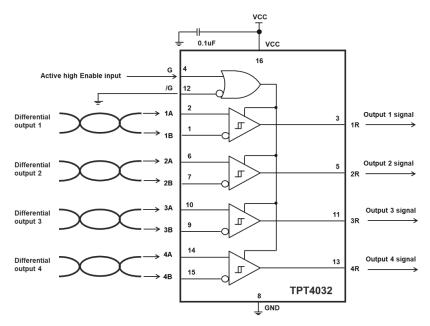


Figure 5. Typical application reference circuit

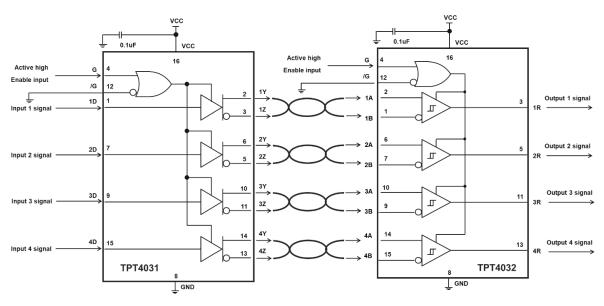


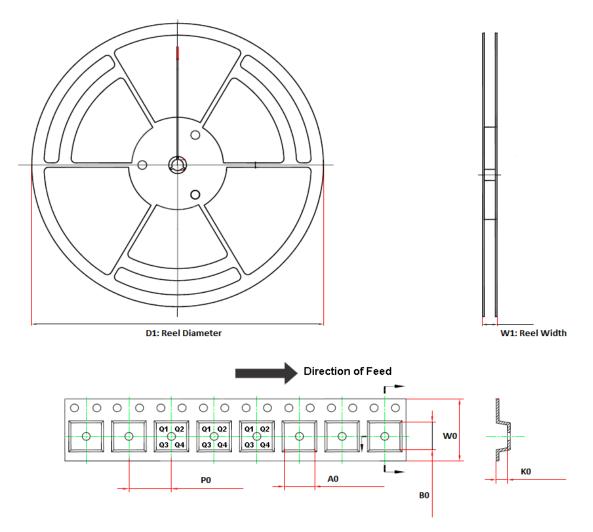
Figure 6. Typical application reference circuit

Resistor and capacitor termination values are shown for each lab experiment, but vary from different system. For example, the termination resistor,  $R_T$ , must be within 20% of the characteristic impedance, Zo, of the cable and can vary from about 80  $\Omega$  to 120  $\Omega$ .

Place 0.1µF bypass capacitors is required close to the power-supply pins to reduce errors coupling in from noisy or high impedance power supplies.



# Tape and Reel Information

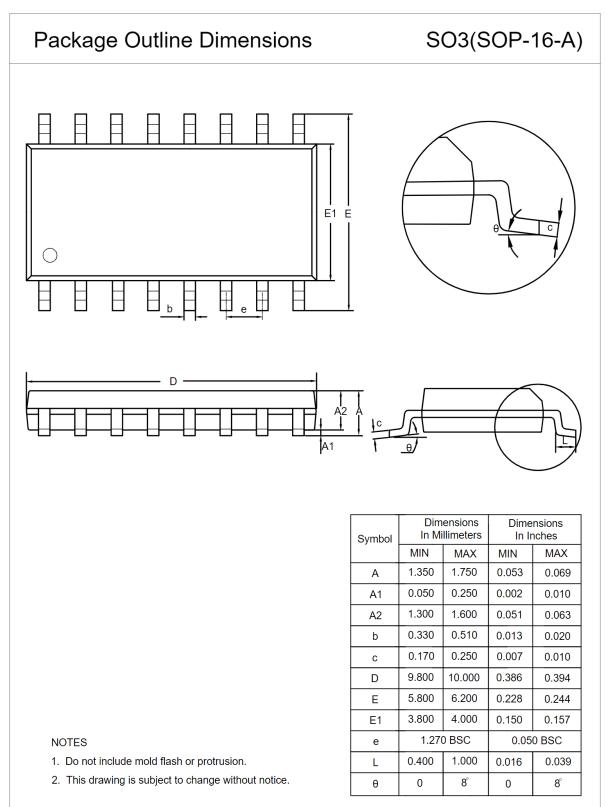


Order Number	Package	D1 (mm)	W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	W0 (mm)	Pin1 Quadrant
TPT4032-SO3R	SOP16	330	21.6	6.7	10.4	2.1	8.0	16.0	Q1
TPT4032-TS3R	TSSOP16	330	17.6	6.8	5.4	1.7	8.0	12.0	Q1



## **Package Outline Dimensions**

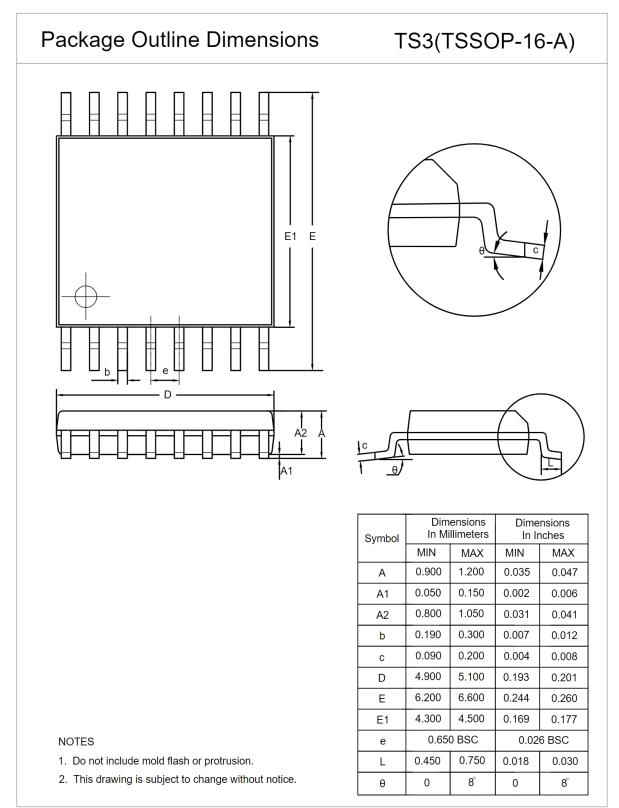
### SO3R (SOP16)





## **Package Outline Dimensions**

### TS3R (TSSOP16)





### **Order Information**

Order Number	Operating Temperature Range	Package	Marking Information	MSL	Transport Media, Quantity	Eco Plan
TPT4032-SO3R	-40 to 125°C	16-Pin SOP	T4032	3	Tape and Reel, 2500	Green
TPT4032-TS3R	-40 to 125°C	16-Pin TSSOP	T4032	3	Tape and Reel, 3000	Green

(1) Green: 3PEAK defines "Green" to mean RoHS compatible and free of halogen substances.

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